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Aging and conductivity of electrodes for high rate tRPCs from an ion conductivity approach

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Outline

- ▶ Outlook of electric high rate RPCs plate requirements
- ▶ Dielectric constant measurements
- ▶ Conductivity types on insulators
- ▶ Processes activated by temperature
- ▶ Ionic current model
- ▶ Ionic aging model

Plate impedance effects for high rate RPCs

- ▶ DC Model : Disregard perturbation effects, so observables are just function of the **primary rate** (ϕ_p) and **the column resistivity** (ρd).
- ▶ **Resistivity:** Low ρd values improves rate capability (k) :

$$k = \frac{\rho_0 d_0}{\rho d}$$

- ▶ **Permittivity:** Characteristic dielectric perturbation time should be checked:

$$\tau \sim RC$$

Plate resistivity limits

- ▶ **Higher the resistivity** higher the loss of effective E field in the gap, therefore less efficiency at high rates.

$$V_{\text{gap}} = I R_{\text{plate}} - \phi_p \rho d$$

But

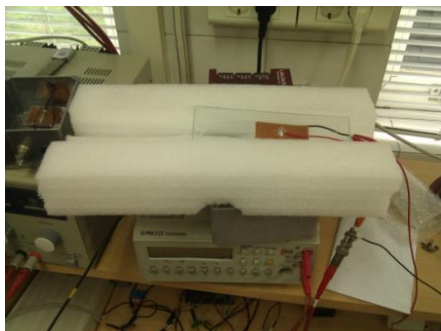
- ▶ **Low resistivity:** Greater current paths and more death time as PPC limit is approached.

Materials Under Test

		Materials	Provider
GLASSES			
		Soda Lime Silicate Glass (SLS Glass)	Hades
		Low Resistive Silicate Glass (LRS Glass)	Tsinghua University
POLYMERs			
		Bakelite	CMS
CERAMICs			
		Mullite/Mo	Developed in collaboration with ICMM/CSIC
		Ferrite Ceramic	Developed in collaboration with ICMM/CSIC

Measurement Setups

From the simplest one:



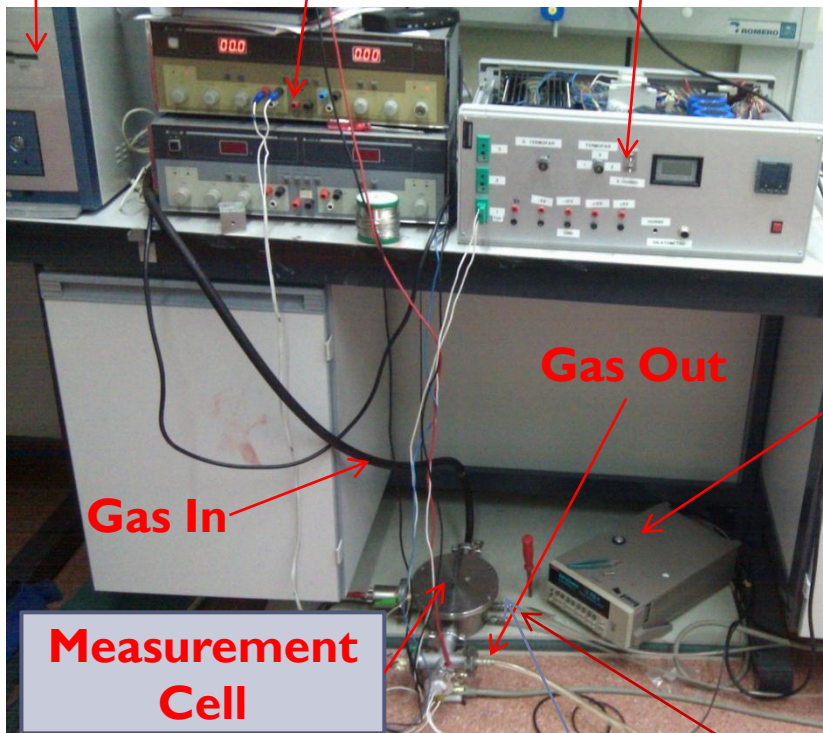
LCR HP4284A 1MHz



Computer

DC Power Supply

**Temperature
DAQ system**



**Control:
Peltier power**

**Read:
PT100**

**Electrometer
Keithley 6517A**

*(Up to 1KV
Voltage src.)*

Gas In

Gas Out

**Measurement
Cell**

**Peltier
Heat Transfer:**

Water In Water Out

Dielectric Constant

Parallel plate capacitor:

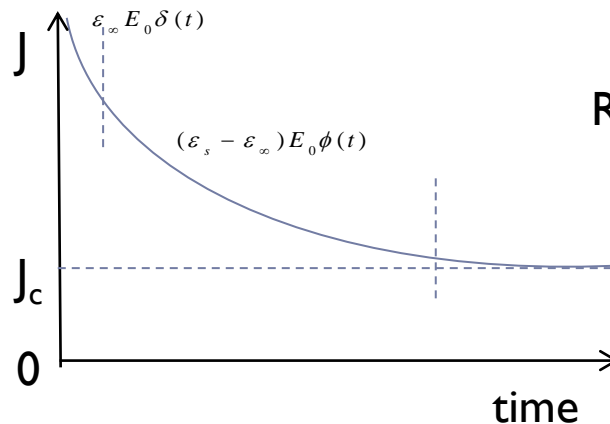
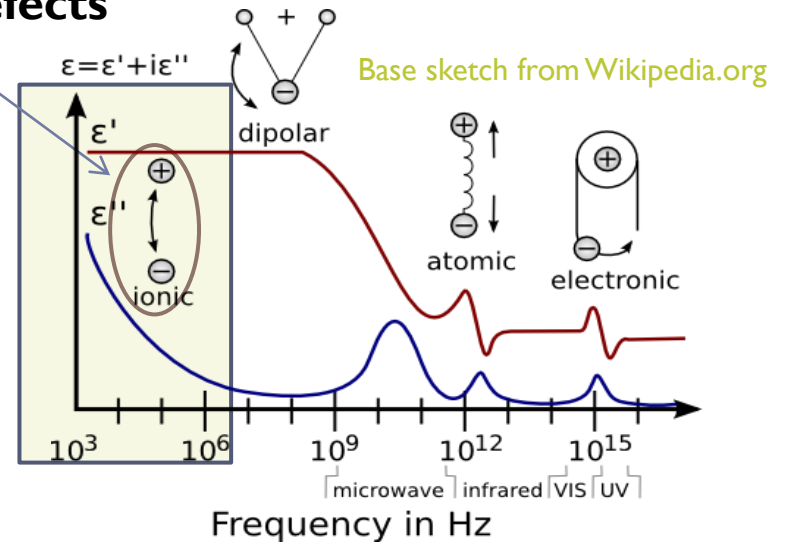
$$C = \epsilon_r \frac{A}{d}$$

Energy stored in the plate:

$$W = \frac{A}{2d} \epsilon_r V^2$$

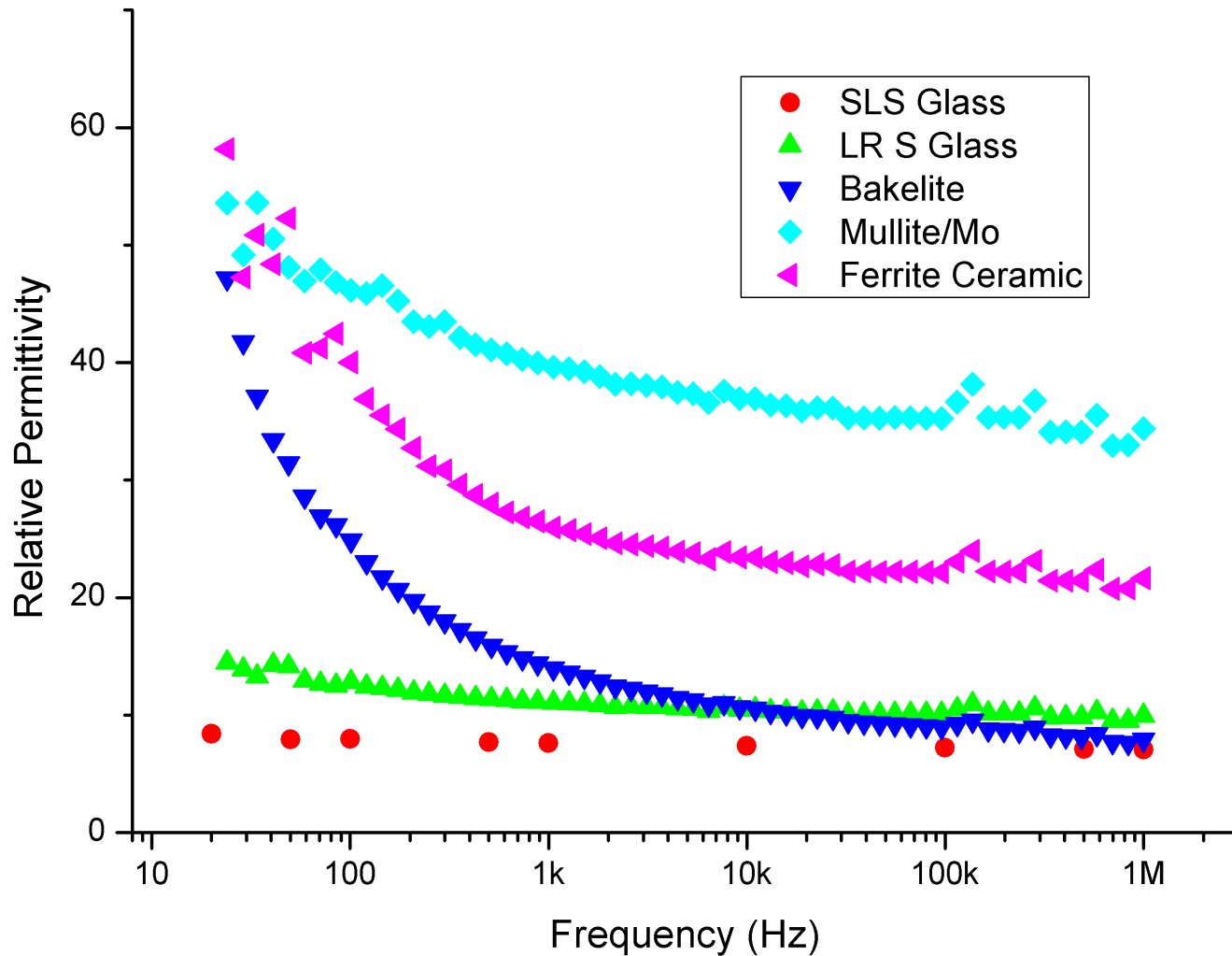
Could damage the FEE or even cause material breakdown.

Network defects



Relax time:
 $\tau \sim RC$

Materials Dielectric Constant



Insulator Conductivity Types

Controlled by the Insulator		
	J(V)	J(T)
Ohmmic	$J \sim V$	$\log(J/E) \sim 1/T$
Poole-Frenkel	$\log(J/V) \sim V^{1/2}$	$\log(J) \sim 1/T$
Space Charge Limit	$J \sim V^2$	T add carriers
Ionic	$J \sim V$	$\log(J/E) \sim 1/T$
Controlled by the electrode		
	J(V)	J(T)
Tunelling	Strong rising with V	Almost independent
Field Emission	$J \sim V^2 \exp(-b/V)$	Almost independent
Schottky	$\log(J/V) \sim V^{1/2}$	$\log(J/T^2) \sim 1/T$

Conductivity Types Identification Issues

- ▶ Usually **more than one conductivity** type is involved.
- ▶ **Relaxation times** longer than we would like.
- ▶ Keep in the **right range of electric field and temperature** to identify the conductivity type.
- ▶ **Not homogeneous** effective **electric field** inside the material due to phases of different conductivities.
- ▶ Different conductivity types could arise changing the **gas environment**.
- ▶ Interference from the resistance or the capacities of the **measurement devices**.
- ▶

Arrhenius process: Activation Energies

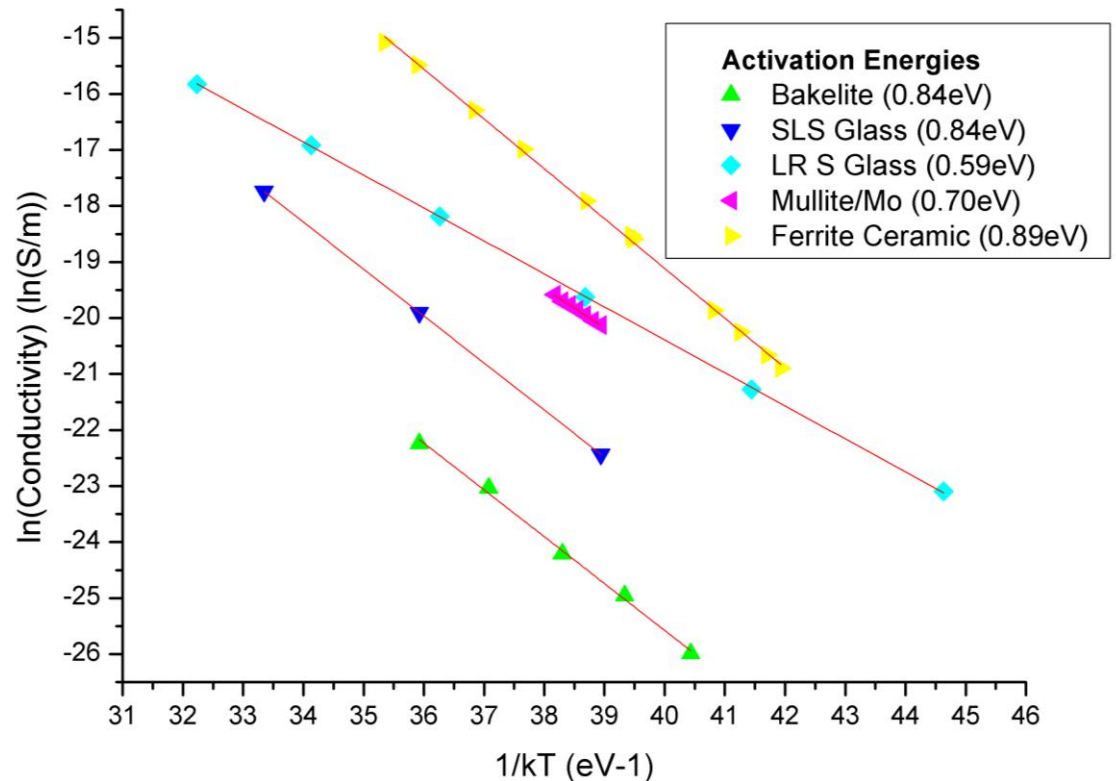
Conductivity (σ):

$$\sigma = \sigma_0 e^{-\frac{E_a}{kT}}$$

Ea: Activation energy
K: Boltzman constant
T: Temperature

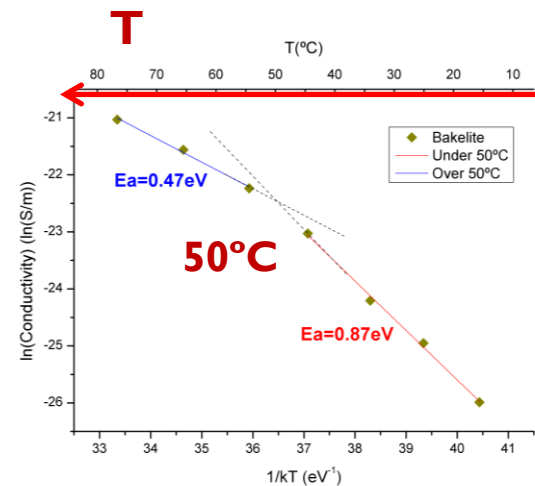
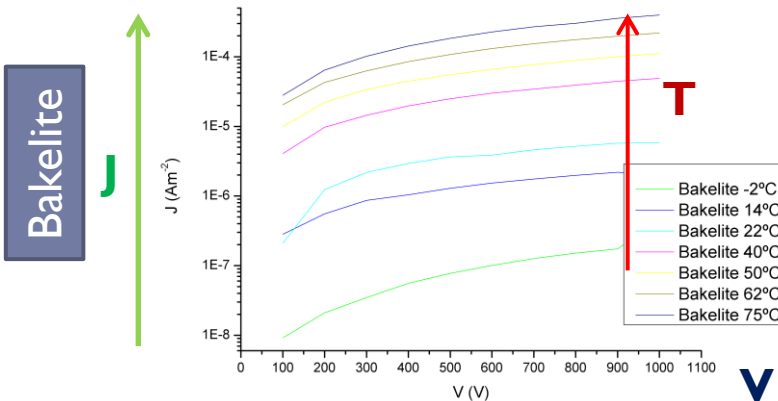
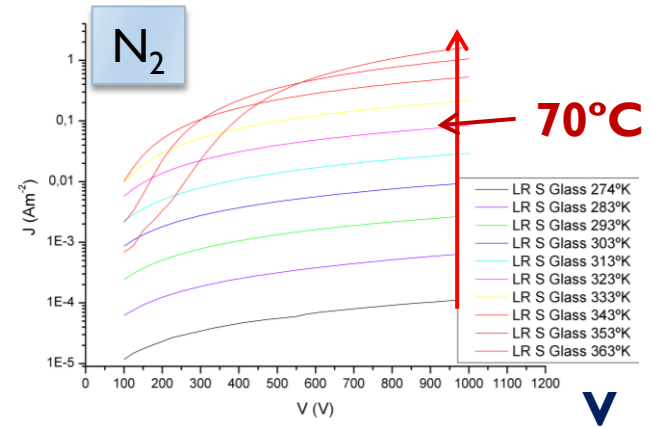
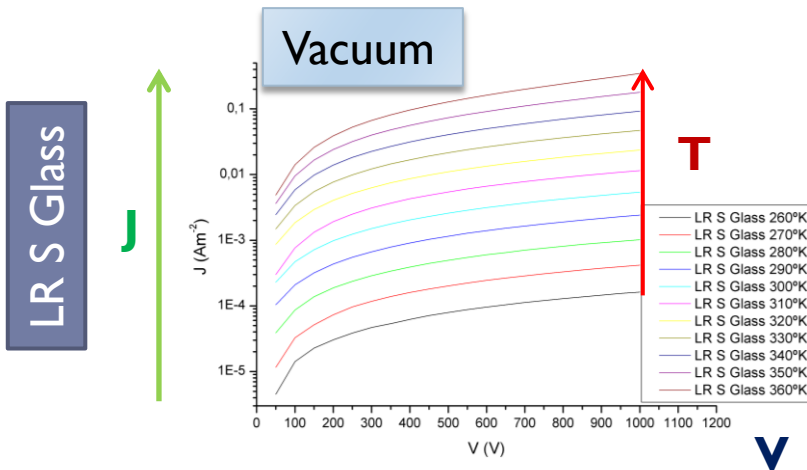
Ea related with the activation energies for **defects generation** and **ion migration**

Material	Ea(eV)
LR S Glass	0.59
Mullite/Mo	0.70
Bakelite	0.84
SLS Glass	0.84
Ferrite Ceramic	0.89



Activation Energies: gas and temperature effects

LR S Glass $T > 70^\circ\text{C}$ and Bakelite $T > 50^\circ\text{C}$, E_a shift



Ionic Current

$$J = nq \mu$$

[Hyde and Tomozawa, 1986]

$$J = nq \left\{ 2 l v_0 e^{-\frac{W}{kT}} \sinh \left(\frac{qEl}{2kT} \right) \right\}$$

Mobility

J: Current density

n: Number of charge carriers

q: Ion charge

μ : carrier mobility

l: Mean free path

v_0 : natural frequency in the well (10^{13} Hz)

W: barrier potential

E: Electric Field

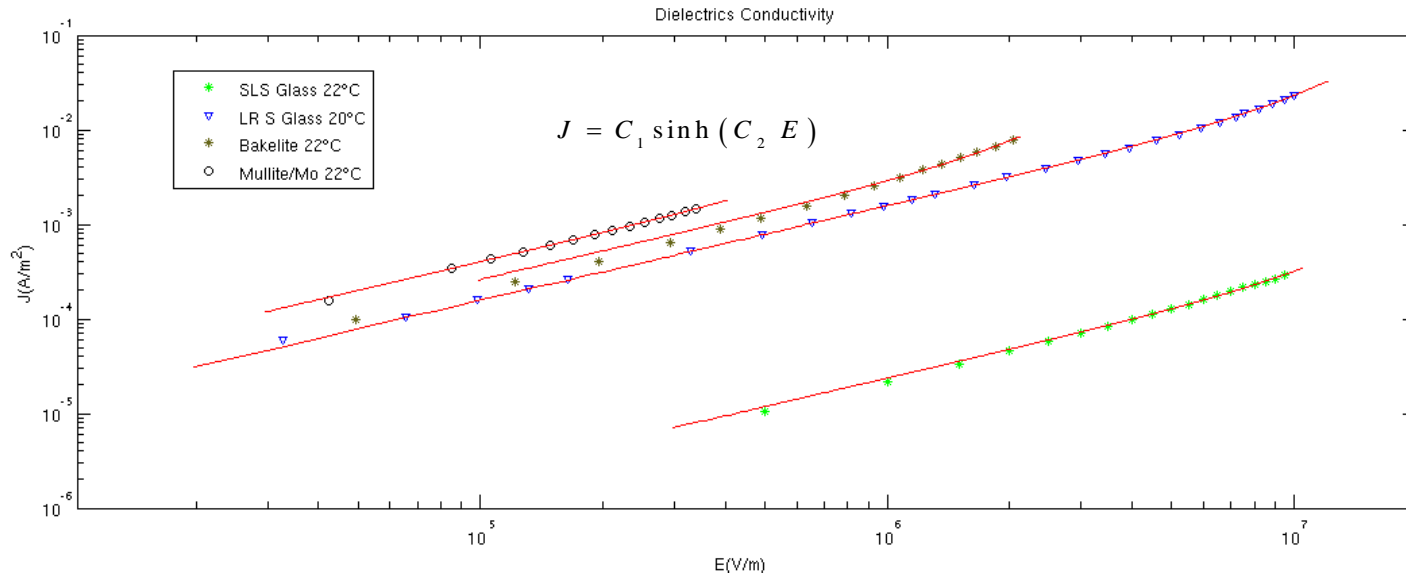
K: Boltzman constant

T: Temperature

Fitting variables:

$$J = C_1 \sinh(C_2 E) \Rightarrow \begin{cases} C_1 = 2 l q v_0 n e^{-\frac{W}{kT}} \\ C_2 = \frac{ql}{2kT} \end{cases} \Rightarrow \begin{cases} \rho = \frac{1}{C_1 C_2} \\ l = \frac{2kT}{q} C_2 \end{cases} \begin{matrix} \text{Resistivity} \\ \text{Mean Free Path} \end{matrix}$$

Ionic Current Fitting



	$C_1(\text{A m}^{-2})$	$C_2(\text{m V}^{-1})$	Rho(Ohm m)	l (m)
SLS Glass	$1.7 \pm 0.2 \cdot 10^{-4}$	$1.4 \pm 0.1 \cdot 10^{-7}$	$4.2 \pm 0.7 \cdot 10^{10}$	$7.0 \pm 0.6 \cdot 10^{-9}$
LR S Glass	$1.00 \pm 0.01 \cdot 10^{-2}$	$1.57 \pm 0.01 \cdot 10^{-7}$	$6.4 \pm 0.1 \cdot 10^8$	$7.9 \pm 0.2 \cdot 10^{-9}$
Bakelite	$3.3 \pm 0.4 \cdot 10^{-3}$	$7.8 \pm 0.7 \cdot 10^{-7}$	$3.8 \pm 0.8 \cdot 10^8$	$4.0 \pm 0.4 \cdot 10^{-9}$
Mullite/Mo	$2.0 \pm 0.1 \cdot 10^{-3}$	$2.0 \pm 0.1 \cdot 10^{-6}$	$2.5 \pm 0.3 \cdot 10^8$	$1.0 \pm 0.08 \cdot 10^{-7}$

Simple Ionic Ageing Model

Carrier density loss:

$$\frac{dn}{dt} = - \frac{J}{qd}$$

Low or moderate field **approximation:** $qEl \ll kT$

$$J(t) = l^2(t) n(t) \frac{Ev_0 q^2}{kT} e^{-\frac{w}{kT}}$$

$$n(t) = \frac{J(t)}{l^2(t)} \cdot \frac{kT}{Ev_0 q^2} e^{\frac{w}{kT}}$$

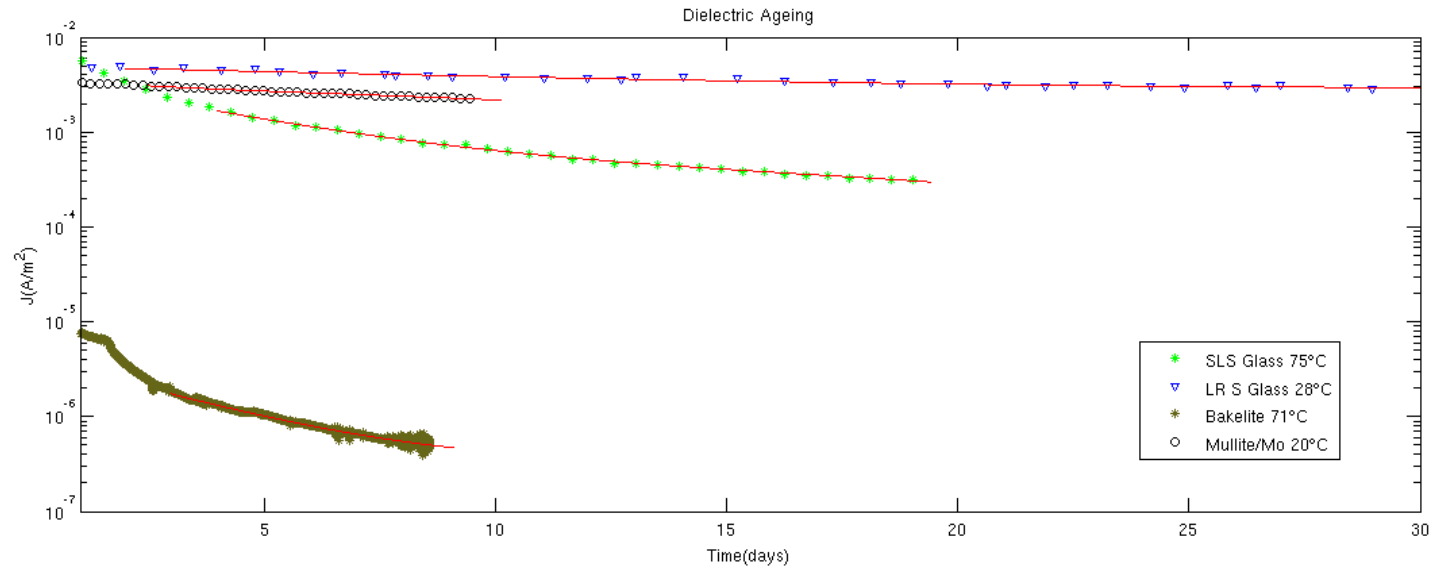
Let the **mean free path** be:

$$l(t) = l_0 \left(1 - \frac{t}{\tau_1} + \frac{t^2}{\tau_2} \right)$$

Final current time function from the model:

$$J(t) = J_0 \left[1 - 2 \frac{t}{\tau_1} + t \left(\frac{1}{\tau_1^2} + \frac{1}{\tau_2} \right) \right] e^{\frac{t}{\tau_n} \left[1 - \frac{t}{\tau_1} + \frac{t^2}{3} \left(\frac{1}{\tau_1^2} + \frac{1}{\tau_2} \right) \right]}$$

Fitting to the ionic aging model

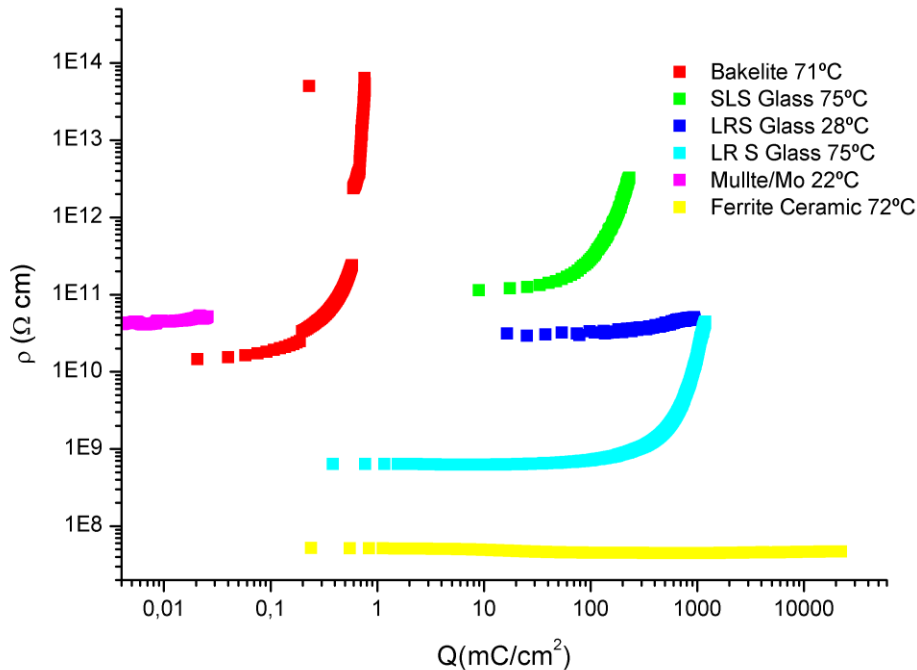


$$f_i = \frac{1}{\tau_i}$$

	J_0 (A m ⁻²)	f_1 (Hz)	f_2 (Hz)	f_n (Hz)
SLS Glass	$4.2 \pm 0.6 \cdot 10^{-3}$	$3.8 \pm 0.6 \cdot 10^{-2}$	$3.1 \pm 0.8 \cdot 10^{-2}$	$1.8 \pm 0.3 \cdot 10^{-1}$
LR S Glass	$4.9 \pm 0.3 \cdot 10^{-3}$	$1 \pm 1 \cdot 10^{-2}$	$1.1 \pm 0.3 \cdot 10^{-2}$	$1 \pm 4 \cdot 10^{-2}$
Bakelite	$4.45 \pm 0.06 \cdot 10^{-6}$	$6.8 \pm 0.3 \cdot 10^{-2}$	$3.20 \pm 0.05 \cdot 10^{-2}$	$2.1 \pm 0.1 \cdot 10^{-2}$
Mullite/Mo	$3.7 \pm 0.2 \cdot 10^{-3}$	$3 \pm 6 \cdot 10^{-3}$	$5 \pm 1 \cdot 10^{-2}$	$8 \pm 1 \cdot 10^{-2}$



Resistivity change aging



Drifted charge		
Material	T(°C)	Q(mC/cm ²)
SLS Glass	75	230
LR S Glass	28	900
	75	1190
Bakelite	72	0.8
Mullite/Mo	22	0.025
Ferrite Ceramic	72	22 000

Note: Expected Charge transfered by the CBM RPCs

$$Q/A = 5y \times 0.5 \times 20 \text{ KHz/cm}^2 \times 1.5\text{pC/gap} = 2\text{C/cm}^2$$

Summary

- ▶ Methods from Material Science have been introduced to test some RPCs plates and other materials.
- ▶ Dielectric constant up to 1MHz have been measured
- ▶ Activation energies have been used to set the temperature limit for testing material ageings.
- ▶ An Ionic approach model for the $J(E)$ and $J(t)$ has been proposed to match Ionic conductivity involved in the current.
- ▶ **TODO:**
- ▶ Add other effects more than the charges carriers depletion to the ageing model, as space charge or electrode pasivation.
- ▶ Test other mean free path functions.
- ▶ Measure bakelite ageing with a fair setup, lower temperature.
- ▶ Put at least one ceramic used for high rate RPCs under test.
- ▶ Test impedances up to GHz.

Thanks

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- ▶ Institute of Materials Science Research of Madrid (**ICMM /CSIC**)

- ▶ Nanomaterials and Nanotechnology Research Center of Asturias (**CINN/CSIC**)

Thank you for your attention!!

References

[Hyde and Tomozawa, 1986] Hyde, J.M. and M.Tomozawa, The Relationship Between The Dielectric Relaxation And The High-Field Conduction Of Glasses. *Physics and Chemistry of Glasses*, 1986. 27(4): p. 147-151.



Backup Slides

values for τ_n and τ_l are:

	J_0 (Am ⁻²)	τ_n (days)	τ_l (days)	t (days)	E (V/m)	C·c m ⁻²
Mu/M	0.006	19.76	112.2	10	2.	0.4
o (r.t.)	6		4		2·10 ⁵	4
Glass	0.002	18.85	184.3	36	9.	0.2
(50°C)	7		4		6·10 ⁶	2

	C_1	C_2	ρ	l
	(Am^2)		($\Omega\cdot\text{m}$)	(nm)
11%	(2.05±0.	(1.9±0.1)·	2.6·	98
Mu/Mo	2)·10 ⁻³	10 ⁻⁶	10 ⁸	
12%	(2.18±0.	(1.86±0.0	2.5·	93
Mu/Mo	1)·10 ⁻³	9)·10 ⁻⁶	10 ⁸	
13%	(1.47±0.	(5.0±0.2)·	1.3·	26
Mu/Mo	2)·10 ⁻³	10 ⁻⁶	10 ⁸	0
Fresh	(2.0±0.1	(1.23±0.0	4.1·	6
Float glass)·10 ⁻⁴	5)·10 ⁻⁷	10 ¹⁰	
Aged	(1.6±0.3	(1.5±0.1)·	4.1·	8
Float glass)·10 ⁻⁵	10 ⁻⁷	10 ¹¹	

Cuts

$$\ln \sigma = \ln \sigma_0 - \frac{Ea}{kT}$$

In band theory:

$$Ea = \frac{E_g}{2}$$

Eg: Gap band energy

Ionic ageing model simplification:

If $t_l \gg t_n$ then the solution:

$$J = J_0 e^{-\frac{t}{\tau_n} \left(1 - \frac{t}{\tau_l}\right)} \quad \tau_n = \frac{d kT e^{\frac{W}{kT}}}{l_0^2 v_0 q E}$$